

Supporting Information to

Transparent conductive nanoporous aluminium mesh prepared by electrochemical anodizing

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Evaluation of ϕ_f and ϕ_{crit} values for the hexagonally arranged Al nanoporous mesh

Figure S1 shows the geometrical model based on [1] for the calculation of Al nanoporous mesh volumes ϕ_f and ϕ_{crit} .

According to this model, the values of ϕ_f and ϕ_{crit} are:

$$\phi_f = \frac{V_{r_f} - (V_p - V_{ppi} - V_{pc_f})}{V_{r_f}}, \quad (1)$$

$$\phi_{crit} = \frac{V_{r_{crit}} - (V_p - V_{ppi} - V_{pc_{crit}})}{V_{r_{crit}}}, \quad (2)$$

where V_r is the volume of the simulation rectangular unit cell, V_p is the volume of semisphere, V_{ppi} is the volume of the semisphere-semisphere intersection and V_{pc} is the volume of the spherical cap. The parameters V_p and V_{ppi} are same for both ϕ_f and ϕ_{crit} . Taking into account that the simulation unit cell contains two whole pores, V_p and V_{ppi} are:

$$V_p = \frac{1}{3} \pi d^3, \quad (3)$$

$$V_{ppi} = \frac{1}{4} \pi (2d+a)(d-a)^2, \quad (4)$$

where d and a are the pore diameter and the interpore distance respectively.

The values of V_{r_f} , $V_{r_{crit}}$, V_{pc_f} and $V_{pc_{crit}}$ can be calculated by

$$V_{r_f} = \sqrt{3}a^2 \left(\frac{d}{a} - h_i \right), \quad (5)$$

$$V_{r_{crit}} = \sqrt{3}a^2 \left(\frac{d}{a} - h_{crit} \right), \quad (6)$$

$$V_{pc_f} = \frac{2}{3}\pi h_i^2 \left(\frac{3}{2}d - h_i \right), \quad (7)$$

$$V_{pc_{crit}} = \frac{2}{3}\pi h_{crit}^2 \left(\frac{3}{2}d - h_{crit} \right), \quad (9)$$

where h_i and h_{crit} are the distances from the bottom of pore to the substrate as shown in Fig. S1. h_i is varied from zero to h_{crit} .

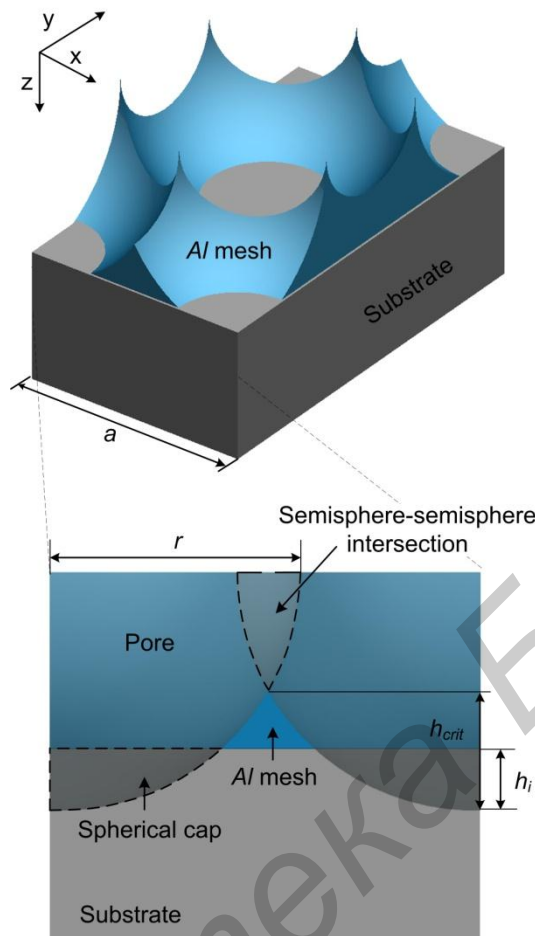


Figure S1 Schematic diagram (left) and cross-section (right) of the simulation unit cell of the hexagonally arranged Al nanoporous mesh.

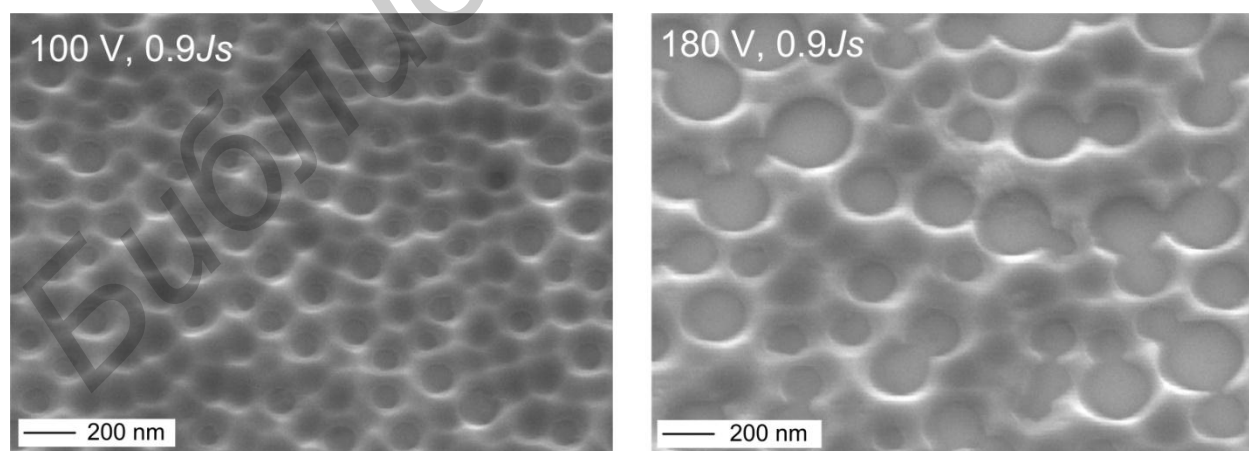


Figure S2 Enlarged SEM images of the Al nanoporous mesh obtained by the anodizing at the applied voltages of 100 (left) and 180 (right) V and the current density $0.9J_1$.

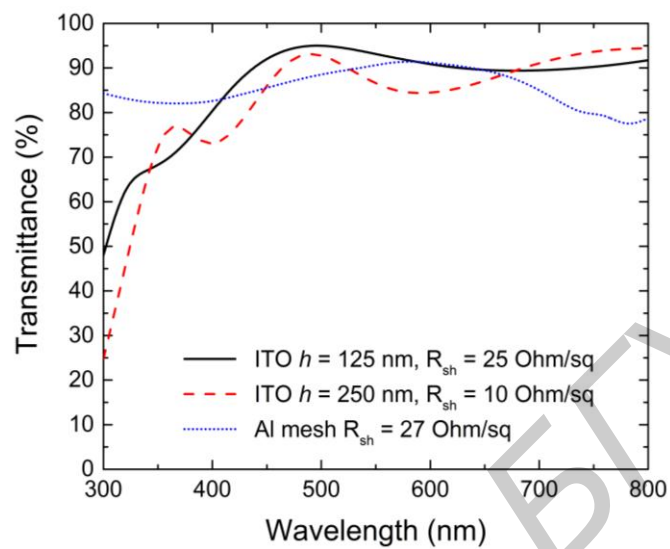


Figure S3 The calculated transmittance against wavelength for the bulk ITO with thickness of 125 and 250 nm and Al nanoporous mesh on the glass substrate. The diameter of pores and inter-pore distance of the Al nanoporous mesh are 180 and 200 nm respectively.

Reference

- [1] F. Keller, M. Hunter, and D. Robinson, J. Electrochem. Soc. **100**, 411 (1953).